



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kie Y. Ahn et al.

Title: MULTILEVEL COPPER INTERCONNECT WITH DOUBLE PASSIVATION

Docket No.: 303.685US2

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Examiner: Michael Trinh

Customer No.: 21186

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Commissioner for Patents

Attn: MAIL STOP ISSUE FEE

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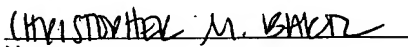
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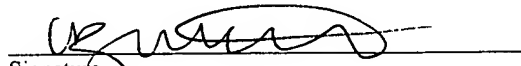
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